

Power Resistor Thick Film Technology



FEATURES

- 100 W at 25 °C case temperature heatsink mounted
- Direct mounting ceramic on heatsink
- Broad resistance range: 0.015 Ω to 1 MΩ
- Non inductive
- TO-247 package: compact and easy to mount
- **AEC-Q200 qualified**
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE

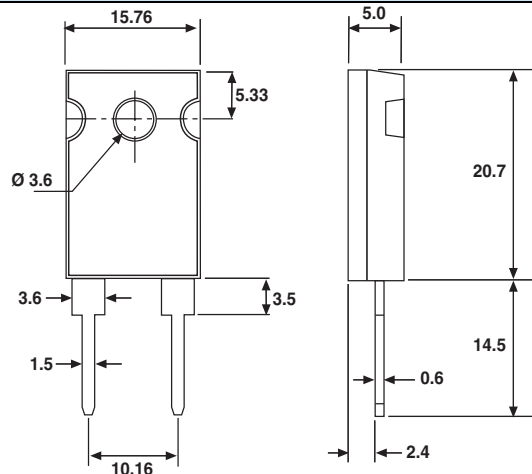

RoHS
COMPLIANT

DESIGN SUPPORT TOOLS

[click logo to get started](#)
3D
Models
Available

LTO series are the extension of RTO types. We used the direct ceramic mounting design (no metal tab) of our RCH power resistors applied to semiconductor packages.

DIMENSIONS in millimeters



Note

- Tolerances unless stated: ± 0.3 mm

STANDARD ELECTRICAL SPECIFICATIONS

| MODEL | SIZE | RESISTANCE RANGE Ω | RATED POWER $P_{25\text{ °C}}$ W | LIMITING ELEMENT VOLTAGE U_L V | TOLERANCE ± % | TEMPERATURE COEFFICIENT ± ppm/°C | CRITICAL RESISTANCE Ω |
|---------|--------|-----------------------|--|-------------------------------------|------------------|-------------------------------------|--------------------------|
| LTO 100 | TO-247 | 0.015 to 1 M | 100 | 500 | 1, 2, 5, 10 | 200, 350, 900 | 2.5 K |

MECHANICAL SPECIFICATIONS

| | |
|-----------------------|---------------|
| Mechanical Protection | Molded |
| Resistive Element | Thick film |
| Substrate | Alumina |
| Connections | Tinned copper |
| Weight | 3.5 g max. |
| Mounting Torque | 1 Nm |

ENVIRONMENTAL SPECIFICATIONS

| | |
|-------------------|--|
| Temperature Range | -55 °C to +175 °C |
| Climatic Category | 55 / 175 / 56 |
| Flammability | IEC 60695-11-5 2 applications 30 s separated by 60 s |

TECHNICAL SPECIFICATIONS

| | |
|--|--|
| Dissipation and Associated | Onto a heatsink |
| Power Rating and Thermal Resistance of the Component | 100 W at +25 °C (case temp.) $R_{TH(j-c)}$: 1.5 °C/W Free air: 3.5 W at +25 °C |
| Temperature Coefficient | See Performance table ± 150 ppm/°C |
| Dielectric Strength MIL STD 202 | 3000 V_{RMS} - 1 min 10 mA max. |
| Insulation Resistance | ≥ 10 ⁴ MΩ |
| Inductance | ≤ 0.1 μH |



| PERFORMANCE | | |
|---------------------------|---|--------------------------------|
| TESTS | CONDITIONS | REQUIREMENTS |
| Momentary Overload | EN 60115-1 1.5 Pr/5 s $U_S < 1.5 U_L$ | $\pm (0.5 \% + 0.005 \Omega)$ |
| Load Life | EN 60115-1 1000 h Pr at +25 °C | $\pm (1 \% + 0.005 \Omega)$ |
| High Temperature Exposure | AEC-Q200 REV D conditions: MIL-STD-202 method 108 1000 h, +175 °C, unpowered | $\pm (0.25 \% + 0.005 \Omega)$ |
| Temperature Cycling | AEC-Q200 REV D conditions: JESD22 method JA-104 1000 cycles, -55 °C to +125 °C dwell time -15 min | $\pm (1 \% + 0.005 \Omega)$ |
| Biased Humidity | AEC-Q200 REV D conditions: MIL-STD-202 method 103 1000 h, 85 °C, 85 % RH | $\pm (1 \% + 0.005 \Omega)$ |
| Operational Life | AEC-Q200 REV D conditions: MIL-STD-202 method 108 2000 h, 90/30, powered, +125 °C | $\pm (1 \% + 0.005 \Omega)$ |
| ESD Human Body Model | AEC-Q200 REV D conditions: AEC-Q200-002 25 kV _{AD} | $\pm (0.5 \% + 0.005 \Omega)$ |
| Vibration | AEC-Q200 REV D conditions: MIL-STD-202 method 204 5 g's for 20 min, 12 cycles test from 10 Hz to 2000 Hz | $\pm (0.5 \% + 0.005 \Omega)$ |
| Mechanical Shock | AEC-Q200 REV D conditions: MIL-STD-202 method 213 100 g's, 6 ms, 3.75 m/s 3 shocks/direction | $\pm (0.5 \% + 0.005 \Omega)$ |
| Terminal Strength | AEC-Q200 REV D conditions: AEC-Q200-006 2 kgf, 60 sec | $\pm (0.25 \% + 0.01 \Omega)$ |

| SPECIAL FEATURES | | | |
|---|--------------------------------------|--------------------------------------|--------------------------------------|
| Resistance Values | ≥ 0.015 | ≥ 0.1 | > 20 |
| Tolerances | $\pm 1 \% \text{ at } \pm 10 \%$ | | |
| Typical Temperature Coefficient (-55 ° to +175 °C) | $\pm 900 \text{ ppm/}^\circ\text{C}$ | $\pm 350 \text{ ppm/}^\circ\text{C}$ | $\pm 200 \text{ ppm/}^\circ\text{C}$ |

CHOICE OF THE HEATSINK

The user must choose according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 175 °C. The dissipated power is simply calculated by the following ratio:

$$P = \frac{\Delta T}{[R_{TH(j-c)}] + [R_{TH(c-h)}] + [R_{TH(h-a)}]} \quad (1)$$

- P: Expressed in W
- ΔT : Difference between maximum working temperature and room temperature
- $R_{TH(j-c)}$: Thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component.
- $R_{TH(c-h)}$: Thermal resistance value measured between outer side of the resistor and upper side of the heatsink. This is the thermal resistance of the interface (grease, thermal pad), and the quality of the fastening device.
- $R_{TH(h-a)}$: Thermal resistance of the heatsink.

Example:

$R_{TH(c-h)} + R_{TH(h-a)}$ for LTO 100 power rating 10 W at ambient temperature +25 °C

Thermal resistance $R_{TH(j-c)}$: 1.5 °C/W

Considering equation (1) we have:

$$\Delta T = 175 \text{ }^\circ\text{C} - 25 \text{ }^\circ\text{C} = 150 \text{ }^\circ\text{C}$$

$$R_{TH(j-c)} + R_{TH(c-h)} + R_{TH(h-a)} = \frac{\Delta T}{P} = \frac{150}{10} = 15 \text{ }^\circ\text{C/W}$$

$$R_{TH(c-h)} + R_{TH(h-a)} = 15 \text{ }^\circ\text{C/W} - 1.5 \text{ }^\circ\text{C/W} = 13.5 \text{ }^\circ\text{C/W}$$

with a thermal grease $R_{TH(c-h)} = 1 \text{ }^\circ\text{C/W}$, we need a heatsink with $R_{TH(h-a)} = 12.5 \text{ }^\circ\text{C/W}$.

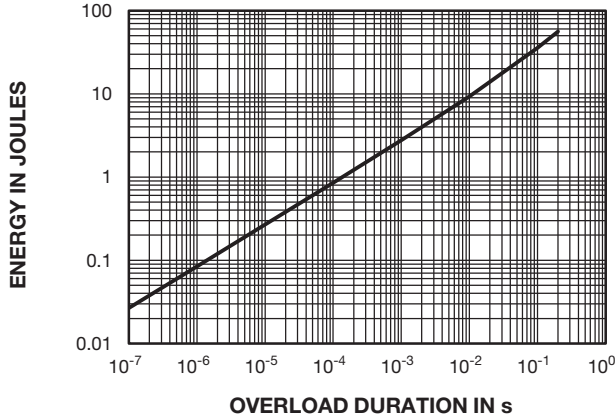


OVERLOADS

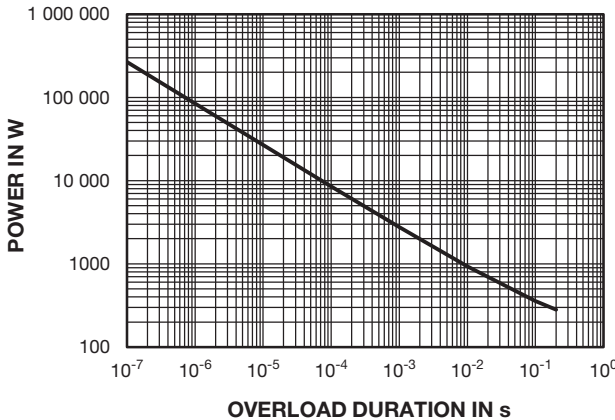
In any case the applied voltage must be lower than the maximum overload voltage of 750 V.

The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.

ENERGY CURVE



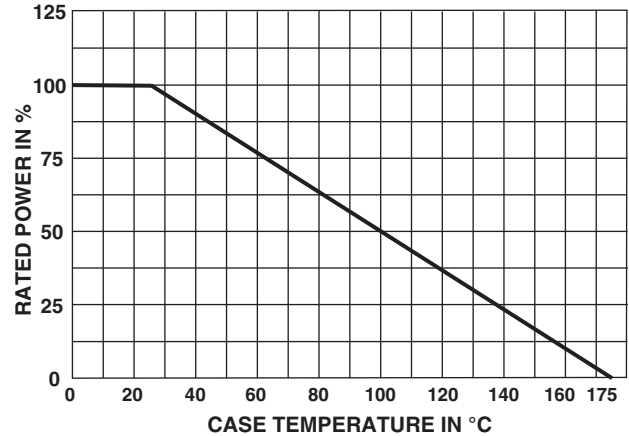
POWER CURVE



POWER RATING

The temperature of the case should be maintained within the limits specified.

To improve the thermal conductivity, surfaces in contact should be coated with a silicone grease and the torque applied on the screw for tightening should be around 1 Nm.



| PACKAGING |
|------------------|
| Tube of 30 units |

MARKING

Model, style, resistance value (in Ω), tolerance (in %), manufacturing date, Vishay Sfernice trademark.



| ORDERING INFORMATION | | | | | | | |
|----------------------|-------|-------------|------------------|-----------------------------------|---|-----------|----------------|
| LTO | 100 | F | 2.7 kΩ | ± 1 % | xxx | TU30 | e3 |
| MODEL | STYLE | CONNECTIONS | RESISTANCE VALUE | TOLERANCE | CUSTOM DESIGN | PACKAGING | LEAD (Pb)-FREE |
| | | | | ± 1 % ± 2 % ± 5 % ± 10 % | Optional on request: special TCR, shape etc. | | |

| GLOBAL PART NUMBER INFORMATION | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|---|------|------------------|--|---|---|---|--|--|----------------------|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| <table border="1" style="margin: auto;"> <tr> <td>L</td><td>T</td><td>O</td><td>1</td><td>0</td><td>0</td><td>F</td><td>2</td><td>7</td><td>0</td><td>0</td><td>0</td><td>J</td><td>T</td><td>E</td><td>3</td> </tr> </table> | | | | | | | | | | | | | | L | T | O | 1 | 0 | 0 | F | 2 | 7 | 0 | 0 | 0 | J | T | E | 3 |
| L | T | O | 1 | 0 | 0 | F | 2 | 7 | 0 | 0 | 0 | J | T | E | 3 | | | | | | | | | | | | | | |
| GLOBAL MODEL | SIZE | LEADS | OHMIC VALUE | | | | TOLERANCE | PACKAGING | LEAD (Pb)-FREE | | | | | | | | | | | | | | | | | | | | |
| LTO | 100 | F = radial leads | <p>The first four digits are significant figures and the last digit specifies the number of zeros to follow. R designates decimal point.</p> <p>48R70 = 48.7 Ω 48701 = 48 700 Ω 10002 = 100 000 Ω R0100 = 0.01 Ω R4700 = 0.47 Ω 27000 = 2700 Ω = 2.7 kΩ</p> | | | | <p>F = 1 % G = 2 % J = 5 % K = 10 %</p> | <p>T = tube Tube 30 pieces</p> | E3 = pure tin | | | | | | | | | | | | | | | | | | | | |



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